

**PI2EQX638**

**1.8V 5.0Gbps, 2-port, USB 3.0 Mux/DeMux ReDriver™**

**Features**

- USB 3.0 compatible
- Full Compliancy to USB3.0 Super Speed Standard
- 1 to 2 DeMux from host TX to device RX
- 2 to 1 Mux from device TX to Host RX
- Pin Adjustable Receiver Equalization
- Pin Adjustable output swing
- Pin Adjustable Output Emphasis
- 100Ω Differential CML I/O's
- Input signal level detect and squelch for each channel
- Automatic Receiver Detect
- Low Power : 200mw
- Adaptive power management
  - ◆ 0.54mW/0.3mA (typ) in U2/U3 state
  - ◆ 0.54mW/0.3mA (typ) in no connection state
  - ◆ 26mW/14mA (typ) in U1 state
  - ◆ 0.18mW/0.1mA(typ) in Power down state
- Single Supply Voltage: 1.8V
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Packaging:
  - ◆ 18-Pin XUB18 2x2 mm

**Description**

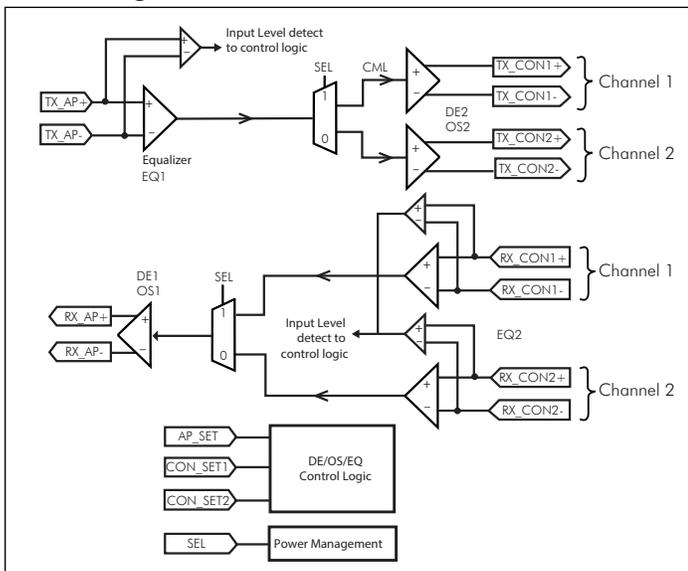
Diodes' PI2EQX638 is a low power, high performance 5.0 Gbps 2-Port USB3.0 Mux / DeMux ReDriver™ designed specifically for the USB 3.0 protocol.

The device provides programmable equalization, swing and De-Emphasis to optimize performance over a variety of physical mediums by reducing Inter-Symbol Interference. PI2EQX638 supports two 100Ω Differential CML data I/O's between the Protocol ASIC to a switch fabric, over cable, or to extend the signals across other distant data pathways on the user's platform.

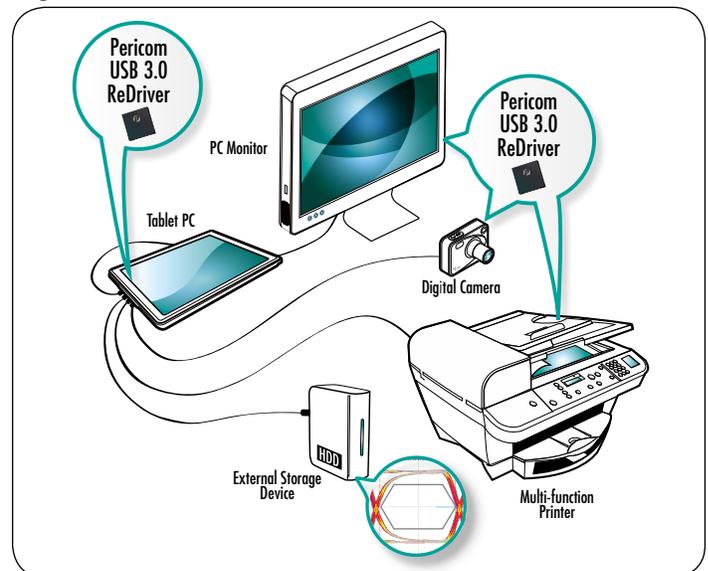
The integrated equalization circuitry provides flexibility with signal integrity of the signal before the ReDriver. A low-level input signal detection and output squelch function is provided for each channel. Each channel operates fully independently. The channels' input signal level (on xI+/-) determines whether the output is active.

The PI2EQX638 also includes an adaptive power management feature to maximize battery life for power sensitive consumer devices.

**Block Diagram**



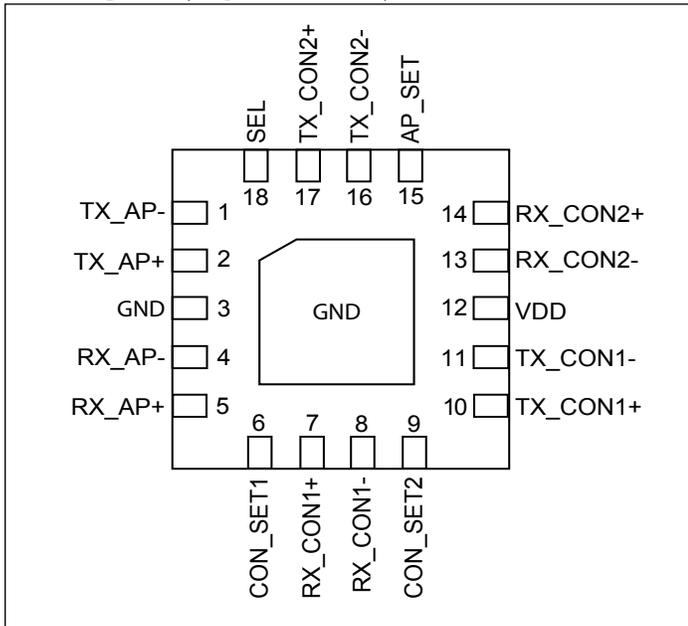
**Figure 1**



**Notes:**

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

**Pin Diagram (Top Side View)**



**Pin Description**

| Pin #                    | Pin Name                                                   | Type   | Description                                                                                                                                                                                                                            |
|--------------------------|------------------------------------------------------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 12                       | VDD                                                        | Power  | 1.8V power supply, +/- 0.1V.                                                                                                                                                                                                           |
| 6, 9                     | CON_SET1, CON_SET2                                         | Input  | Connector Side Setting: DE2/OS2/EQ2 setup. 2 x 3-level input pins. With internal 150K $\Omega$ pull-up resistor and 150k $\Omega$ pull-down resistor.                                                                                  |
| 2, 1<br>7, 8<br>14, 13   | TX_AP+, TX_AP-<br>RX_CON1+, RX_CON1-<br>RX_CON2+, RX_CON2- | Input  | CML input terminals. With selectable input termination between 50 $\Omega$ to internal VbiasRx or 67k $\Omega$ to GND.                                                                                                                 |
| 5, 4<br>10, 11<br>17, 16 | RX_AP+, RX_AP-<br>TX_CON1+, TX_CON1-<br>TX_CON2+, TX_CON2- | Output | CML output terminals. With selectable output termination between 50 $\Omega$ to internal voltage bias, 2K to GND or Hi-Z.                                                                                                              |
| 3, Center Pad            | GND                                                        | GND    | Supply Ground.                                                                                                                                                                                                                         |
| 15                       | AP_SET                                                     | Input  | Application Processor Side Setting: DE1/EQ1 setup 3-level input pins. With internal 150K $\Omega$ pull-up resistor and 150k $\Omega$ pull-down resistor.                                                                               |
| 18                       | SEL                                                        | Input  | Mode Selection Pin. 3-level input pin. With internal 150K $\Omega$ pull-up resistor and 150k $\Omega$ pull-down resistor.<br>"High" – Channel 1 Active<br>"Low" – Channel 2 Active<br>"Float" – Both Channels are power down (Default) |

## Power Management

PI2EQX638 USB3.0 Active Switch includes an adaptive power management feature to support long battery run-time ideal for power-sensitive Smart Mobile Devices. PI2EQX638 is equipped with two differential paths, one is from application processor side to type-C connector side and the other is from type-C connector side to application processor side. Each path has 4 power modes: active mode, slumber mode, deep slumber mode and unplug mode. These power modes are managed by the adaptive power management feature according to the link status. The feature does not decode the USB3.x power management commands to obtain the link status, it relies on link electrical condition, internal timer and internal state machine. Hence, the feature can optimize the power saving in U1 (slumber mode), U2/U3 (deep slumber mode) and no connection state ( Either no device is connected to the type-C connector or the receiver terminal of the connected device is in high impedance mode).

## De-emphasis / Output Swing / Equalization Configuration Table for Application Processor Side:

| Application Processor Side DE/OS/EQ Settings |        |      |              |
|----------------------------------------------|--------|------|--------------|
| AP_SET                                       | DE1    | OS1  | EQ1          |
| 0                                            | 0dB    | 1.1V | 3dB          |
| Float                                        | -3.5dB | 1.1V | 3dB(Default) |
| 1                                            | -3.5dB | 1.1V | 6dB          |

## De-emphasis / Output Swing / Equalization Configuration Table for Connector Side:

| Connector Side DE/OS/EQ Settings |          |        |      |               |
|----------------------------------|----------|--------|------|---------------|
| CON_SET1                         | CON_SET2 | DE2    | OS2  | EQ2           |
| 0                                | 0        | 0dB    | 1.1V | 3dB           |
|                                  | Float    | -3.5dB | 1.1V | 3dB           |
|                                  | 1        | 0dB    | 1.0V | 3dB           |
| Float                            | 0        | -3.5dB | 1.0V | 3dB           |
|                                  | Float    | 0dB    | 1.1V | 6dB (Default) |
|                                  | 1        | -3.5dB | 1.1V | 6dB           |
| 1                                | 0        | 0dB    | 1.0V | 6dB           |
|                                  | Float    | -3.5dB | 1.0V | 6dB           |
|                                  | 1        | -3.5dB | 1.1V | 9dB           |

## Unused Channel and Power down Configuration Table (single ended)

|                               | Input R     | Output R |
|-------------------------------|-------------|----------|
| Unused channel and Power down | 67kΩ to GND | HiZ      |

## Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

|                                         |                                |
|-----------------------------------------|--------------------------------|
| Storage Temperature.....                | -65°C to +150°C                |
| Supply Voltage to Ground Potential..... | -0.5V to +2V                   |
| DC SIG Voltage.....                     | -0.5V to V <sub>DD</sub> +0.5V |
| Output Current.....                     | -25mA to +25mA                 |
| Power Dissipation Continuous.....       | 0.5W                           |
| Operating Temperature.....              | -40°C to +85°C                 |
| ESD, Human Body Model.....              | -2kv to +2kV                   |

### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## RECOMMENDED OPERATING CONDITIONS

| Symbol                        | Parameter                    | Conditions      | Min.                | Typ.               | Max.                | Units |
|-------------------------------|------------------------------|-----------------|---------------------|--------------------|---------------------|-------|
| <b>DEVICE PARAMETERS</b>      |                              |                 |                     |                    |                     |       |
| maximum data rate             |                              |                 |                     |                    | 5                   | Gbps  |
| t <sub>idle_out</sub>         | Slumber mode exit time       | LFPS signal     |                     | 20                 |                     | ns    |
| t <sub>idle_in</sub>          | Slumber mode entry time      | Electrical idle |                     | 1.3                |                     | ms    |
| t <sub>dsm_in</sub>           | Deep Slumber mode entry time | Electrical idle |                     | 330                |                     | ms    |
| <b>Tri-Level Leakage</b>      |                              |                 |                     |                    |                     |       |
| I <sub>IH</sub>               | Input High Current           |                 |                     |                    | 50                  | uA    |
| I <sub>IL</sub>               | Input LOW Current            |                 | -50                 |                    |                     |       |
| <b>Tri-level Control Pins</b> |                              |                 |                     |                    |                     |       |
| V <sub>IH</sub>               | Input High Voltage           |                 | 0.85V <sub>dd</sub> |                    |                     | V     |
| V <sub>IL</sub>               | Input Low Voltage            |                 |                     |                    | 0.15V <sub>dd</sub> |       |
| V <sub>IMID</sub>             | Input Mid Voltage            |                 | 0.35V <sub>dd</sub> | 0.5V <sub>dd</sub> | 0.65V <sub>dd</sub> |       |
| C <sub>L</sub>                | Loading Capacitance          |                 |                     |                    | 150                 | pF    |

## AC/DC Electrical Characteristics

| <b>1.8V Power Supply Characteristics</b> |                                        |                                                                |      |      |      |       |
|------------------------------------------|----------------------------------------|----------------------------------------------------------------|------|------|------|-------|
| Symbol                                   | Parameter                              | Conditions                                                     | Min. | Typ. | Max. | Units |
| V <sub>dd</sub>                          | Supply voltage                         |                                                                | 1.7  | 1.8  | 1.9  | V     |
| I <sub>typ-noDE</sub>                    | Active current consumption @ DE=0      | (5Gbps, compliance test pattern, De-emph=0dB and OS = 1.1V)    |      | 110  | 145  | mA    |
| I <sub>typ-WithDE</sub>                  | Active current consumption @ DE=-3.5dB | (5Gbps, compliance test pattern, De-emph=-3.5dB and OS = 1.1V) |      | 130  | 165  |       |
| I <sub>U1</sub>                          | Current consumption @ U1               | U1 Power - saving state                                        |      | 14   | 25   |       |
| I <sub>U2/U3</sub>                       | Current consumption @ U2/U3            | U2/U3 Power - saving state                                     |      | 0.3  | 1    |       |
| I <sub>pd</sub>                          | Current consumption @ Power down       | Power down state<br>SEL="Float"                                |      | 0.1  | 0.4  |       |
| I <sub>unplug</sub>                      | Current consumption @ Unplug           | No USB connection state                                        |      | 0.3  | 1    |       |

**AC/DC Electrical Characteristics Cont.**

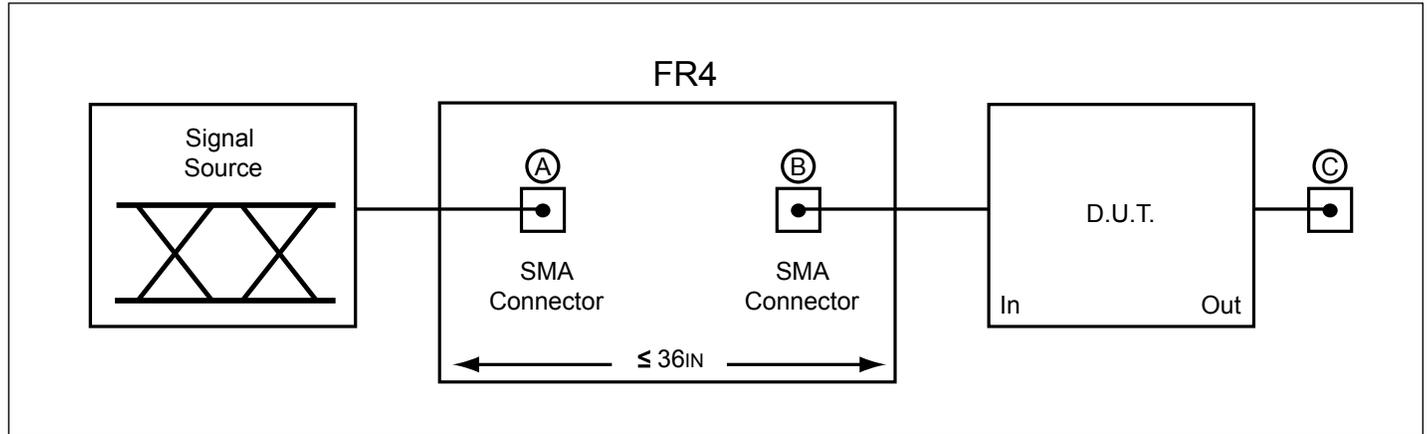
| Symbol                                                                | Parameter                                               | Conditions                                                                                                                                       | Min. | Typ. | Max. | Units      |
|-----------------------------------------------------------------------|---------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------------|
| <b>Receiver AC/DC</b>                                                 |                                                         |                                                                                                                                                  |      |      |      |            |
| $V_{RX-DIFFP-P}$                                                      | Differential Peak-to-Peak Input Voltage                 | AC coupled differential RX peak to peak signal                                                                                                   | 150  |      | 1200 | mVppd      |
| $V_{RX-C}$                                                            | Common Mode Voltage                                     |                                                                                                                                                  |      | 1    |      | V          |
| $V_{cm\_ac}$                                                          | RX AC Common Mode Voltage                               | Measured at Rx pins with termination enabled                                                                                                     |      |      | 150  | mV         |
| $Z_{CM\_RX}$                                                          | DC common mode impedance                                |                                                                                                                                                  | 18   |      | 30   | $\Omega$   |
| $Z_{diff\_RX}$                                                        | DC differential input impedance                         |                                                                                                                                                  | 70   |      | 120  |            |
| $Z_{CM\_RX\_HIZ}$                                                     | DC common mode high impedance                           | Device in unplug mode RX termination measured with respect to AC GND over 500mV max                                                              | 25   |      |      | k $\Omega$ |
| $RL_{RX-DIFF}$                                                        | Differential return loss                                | 50 MHz-1.25GHz                                                                                                                                   |      | 21   |      | dB         |
|                                                                       |                                                         | 1.25 GHz-2.5 GHz                                                                                                                                 |      | 13   |      |            |
| $RL_{RX-CM}$                                                          | Common mode return loss                                 | 50 MHz-2.5 GHz                                                                                                                                   |      | 7    |      | dB         |
| $V_{th\_U0/U1}$                                                       | Input threshold voltage in U0/U1 modes                  | In U0/U1 mode                                                                                                                                    | 50   |      | 150  | mVppd      |
| $V_{th\_upm}$                                                         | LFPS input threshold voltage in no USB connection state | For the path that the receiver termination is not detected. (Notes: uses $V_{th\_U2/U3}$ for the path that the receiver termination is detected) | 150  |      | 650  | mVppd      |
| $V_{th\_U2/U3}$                                                       | LFPS input threshold voltage in U2/U3 modes             | In U2/U3 modes                                                                                                                                   | 150  |      | 650  |            |
| <b>Transmitter Output AC/DC (100<math>\Omega</math> differential)</b> |                                                         |                                                                                                                                                  |      |      |      |            |
| $V_{TX-DIFFP-P}$                                                      | Differential Peak-to-peak Output Voltage                | $V_{TX-DIFFP-P} = 2 *  V_{TX-D+} - V_{TX-D-} $                                                                                                   | 400  |      | 1200 | mVppd      |
| $V_{TX-LFPS}$                                                         | LFPS Differential Peak-to-peak Output Voltage           |                                                                                                                                                  | 800  |      | 1200 |            |
| $V_{TX-C}$                                                            | Common-Mode Voltage                                     | $ V_{TX-D+} + V_{TX-D-} /2$                                                                                                                      | 0.5  |      | 1.2  | V          |
| DE                                                                    | De-emphasis                                             | DE = 0dB                                                                                                                                         |      | 0    |      | dB         |
|                                                                       |                                                         | DE = -3.5dB                                                                                                                                      | -3.0 | -3.5 | -4.0 |            |
| $Z_{diff\_TX}$                                                        | DC differential impedance                               |                                                                                                                                                  | 70   |      | 120  | $\Omega$   |
| $Z_{CM\_TX}$                                                          | DC common mode impedance                                |                                                                                                                                                  | 18   |      | 30   |            |
| $RL_{diff\_TX}$                                                       | Differential return loss                                | f= 50MHz-1.25 GHz                                                                                                                                |      | 18   |      | dB         |
|                                                                       |                                                         | f= 1.25 GHz-2.5 GHz                                                                                                                              |      | 12   |      |            |
| $RL_{CM\_TX}$                                                         | Common mode return loss                                 | f= 50 MHz-2.5GHz                                                                                                                                 |      | 9    |      | dB         |
| $V_{TX\_CM\_AC\_Active}$                                              | TX AC common mode voltage active                        |                                                                                                                                                  |      | 30   | 100  | mVpp       |

**AC/DC Electrical Characteristics Cont.**

| Symbol                                      | Parameter                               | Conditions                                                      | Min. | Typ. | Max. | Units                    |
|---------------------------------------------|-----------------------------------------|-----------------------------------------------------------------|------|------|------|--------------------------|
| V <sub>detect</sub>                         | Voltage change to allow receiver detect | Positive voltage to sense receiver termination                  |      |      | 600  | mV                       |
| t <sub>R,tF</sub>                           | Output rise/fall time                   | 20%-80% of differential voltage measured 1" from the output pin |      | 60   |      | ps                       |
| T <sub>diff_LH</sub> , T <sub>diff_HL</sub> | Differential propagation delay          | Propagation delay between 50% level at input and output         |      | 460  | 1000 | ps                       |
| <b>Jitter Profile</b>                       |                                         |                                                                 |      |      |      |                          |
| T <sub>TX-EYE</sub> <sup>(1)(2)</sup>       | Total jitter(Tj)                        | with 36 inch of inputFR4 trace                                  |      | 0.2  | 0.5  | UI <sup>(3)</sup><br>P-P |
| DJ <sub>TX</sub> <sup>(2)</sup>             | Deterministic jitter(Dj)                |                                                                 |      | 0.1  | 0.3  |                          |
| RJ <sub>TX</sub> <sup>(2)(4)</sup>          | Random jitter(Rj)                       |                                                                 |      | 0.09 | 0.2  |                          |

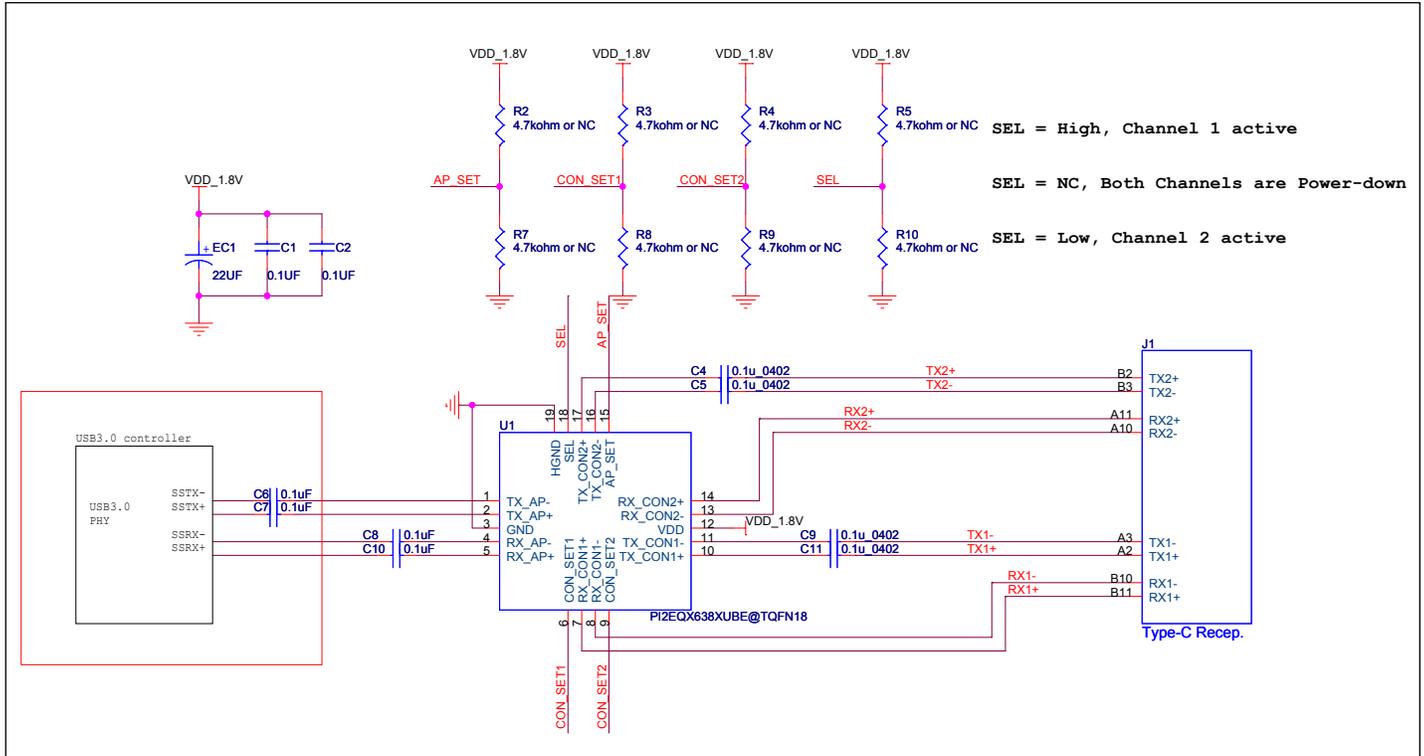
**Note:**

- 1.Includes RJ at 10<sup>-12</sup> BER
- 2.Deterministic jitter measured with PRBS7 pattern, Random jitter measured with 1010 pattern VID=1000mVpp, 5Gbps,
- 3.UI = 200ps
- 4.Rj calculated as 14.069 times the RMS random jitter for 10<sup>-12</sup> BER



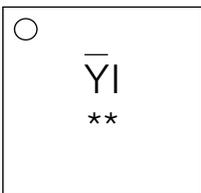
**Test Condition Referenced in the Electrical Characteristic Table**

**Application Schematics**



**Part Marking**

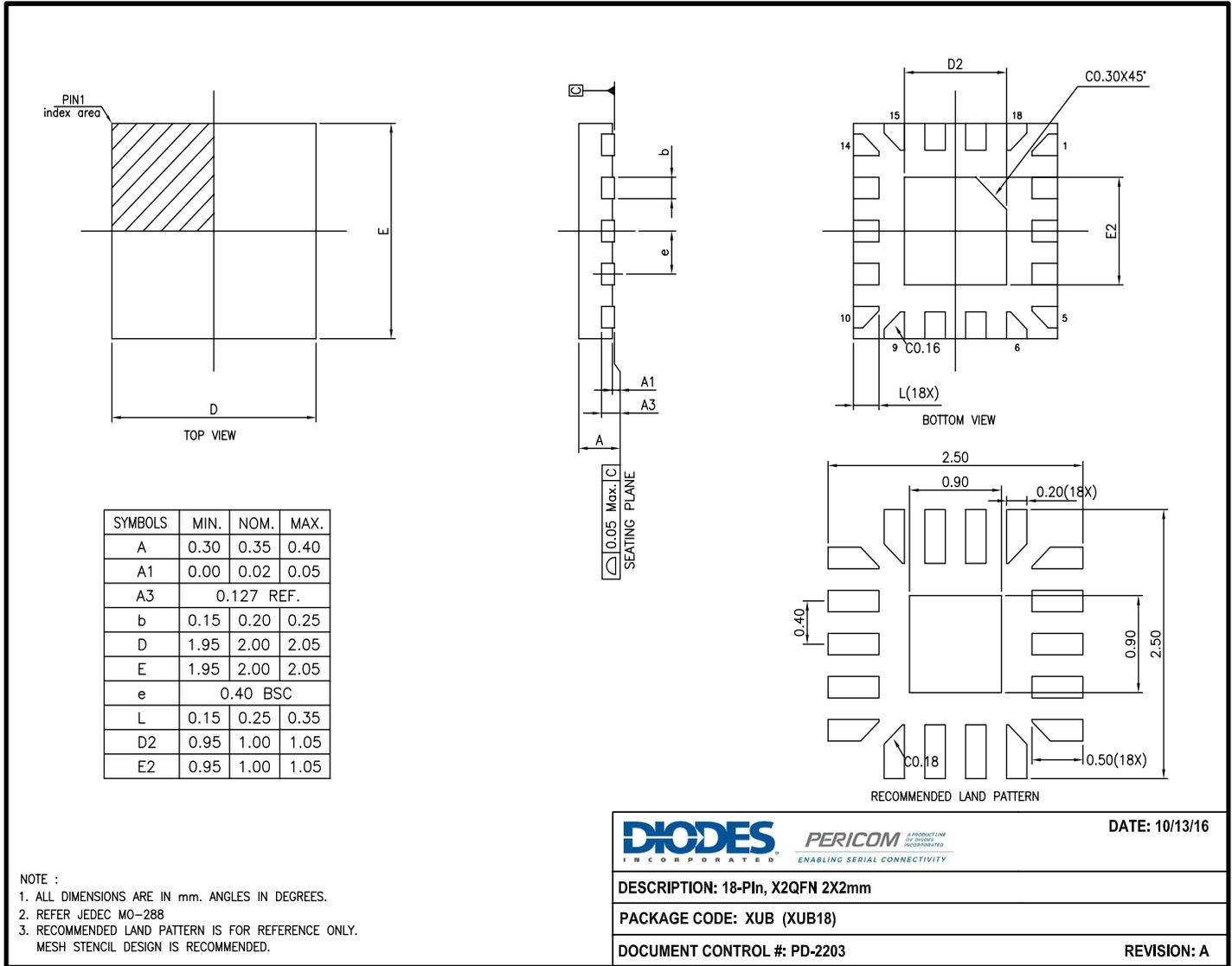
XUB Package



YI: Device name (Top Mark)  
 1st \* of 2nd line: 2nd letter of Option Code  
 2nd \* of 2nd line: 1st letter Datecode

**PI2EQX638**

**Packaging Mechanical: 18-X2QFN (XUB)**



For latest package info.

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

**Ordering Information**

| Ordering Number | Package Code | Package Description   |
|-----------------|--------------|-----------------------|
| PI2EQX638XUBEX  | XUB          | 18-pin, 2x2mm (X2QFN) |

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. E = Pb-free and Green
5. X suffix = Tape/Reel

**IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2016, Diodes Incorporated

[www.diodes.com](http://www.diodes.com)